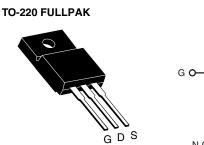
## SiHF22N60S

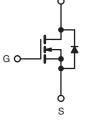
**Vishay Siliconix** 



# **S Series Power MOSFET**

PRODUCT SUMMARY				
V <sub>DS</sub> at T <sub>J</sub> max. (V)	650			
R <sub>DS(on)</sub> max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.190		
Q <sub>g</sub> max. (nC)	98			
Q <sub>gs</sub> (nC)	17			
Q <sub>gd</sub> (nC)	25			
Configuration	Single			





N-Channel MOSFET

## FEATURES

- Generation one
- High E<sub>AR</sub> capability
- Lower figure-of-merit Ron x Qa
- 100 % avalanche tested
- Ultra low Ron
- dV/dt ruggedness
- Ultra low gate charge (Q<sub>a</sub>)
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

#### Note

\* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non-RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details.

### **APPLICATIONS**

- PFC power supply stages
- Hard switching topologies
- Solar inverters
- UPS
- Motor control
- Lighting
- Server telecom

ORDERING INFORMATION			
Package	TO-220 FULLPAK		
Lead (Pb)-free	SiHF22N60S-E3		

ABSOLUTE MAXIMUM RATINGS $T_C$ =	= 25 °C, unless otherwis	e noted			
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V <sub>DS</sub>	600	V		
Gate-Source Voltage	V <sub>GS</sub>	± 30	V		
Continuous Drain Current <sup>a</sup>	$V_{GS} \text{ at } 10 \text{ V}  \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$		22		
	$T_{\rm GS}$ at 10 V $T_{\rm C} = 100 ^{\circ}{\rm C}$	ID	13	A	
Pulsed Drain Current <sup>b</sup>	I <sub>DM</sub>	65	1		
Linear Derating Factor		2	W/°C		
Single Pulse Avalanche Energy c	E <sub>AS</sub>	690	mJ		
Repetitive Avalanche Energy <sup>b</sup>	E <sub>AR</sub>	25			
Maximum Power Dissipation	PD	250	W		
Drain-Source Voltage Slope	T <sub>J</sub> = 125 °C	d\//dt	37	V/ns	
Reverse Diode dV/dt <sup>e</sup>	dV/dt	5.3	v/ns		
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub> -55 to +150				
Soldering Recommendations (Peak Temperature) <sup>d</sup>	for 10 s		300	°C	

### Notes

a. Limited by maximum junction temperature.

b. Repetitive rating; pulse width limited by maximum junction temperature.

c.  $V_{DD}$  = 50 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 7 A.

d. 1.6 mm from case.

e.  $I_{SD} \leq I_D$ , dl/dt = 100 A/µs, starting T<sub>J</sub> = 25 °C.

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# SiHF22N60S

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THERMAL RESISTANCE RATINGS				_	
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R <sub>thJA</sub>	-	65	°C/W	
Maximum Junction-to-Case (Drain)	R <sub>thJC</sub>	-	3.4		

PARAMETER	SYMBOL	vise noted TEST CONDITIONS			TYP.	MAX.	UNIT
Static		L			1		
Drain-Source Breakdown Voltage	V <sub>DS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA		600	-	-	V
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I <sub>D</sub> = 1 mA	-	0.70	-	V/°C
Gate-Source Threshold Voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	· V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.0	V
	30(11) 20 30, 2		$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-Source Leakage	I <sub>GSS</sub>	, v	V <sub>GS</sub> = ± 30 V	-	-	± 1	μA
		V <sub>DS</sub> =	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	5	<u> </u>
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> = 600 V	', V <sub>GS</sub> = 0 V, T <sub>J</sub> = 150 °C	-	-	100	μA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		-	0.160	0.190	Ω
Forward Transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 13 A		-	9.4	-	S
Dynamic		•					
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 25 V, f = 1.0 MHz		-	2810	-	pF
Output Capacitance	C <sub>oss</sub>			-	1480	-	
Reverse Transfer Capacitance	C <sub>rss</sub>			-	33	-	
Effective Output Capacitance (Time Related)	C <sub>oss eff.</sub> (TR) <sup>a</sup>	V <sub>GS</sub> = 0 V	$V_{DS} = 0 V \text{ to } 480 V$	-	155	-	
Total Gate Charge	Qg		1	-	75	110	nC
Gate-Source Charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 22 A, V <sub>DS</sub> = 480 V	-	17	-	
Gate-Drain Charge	Q <sub>gd</sub>			-	25	-	
Turn-On Delay Time	t <sub>d(on)</sub>			-	24	50	-
Rise Time	t <sub>r</sub>	V <sub>DD</sub> =	: 380 V, I <sub>D</sub> = 22 A,	-	68	100	
Turn-Off Delay Time	t <sub>d(off)</sub>	$R_g = 9.1 \Omega, V_{GS} = 10 V$		-	77	115	- ns
Fall Time	t <sub>f</sub>			-	59	90	
Gate Input Resistance	R <sub>g</sub>	f = 1 MHz, open drain		-	0.65	-	Ω
Drain-Source Body Diode Characteristic	s	•					
Continuous Source-Drain Diode Current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	
Pulsed Diode Forward Current	I <sub>SM</sub>			-	-	88	A
Diode Forward Voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C	C, I <sub>S</sub> = 22 A, V <sub>GS</sub> = 0 V	-	-	1.2	V
Reverse Recovery Time	t <sub>rr</sub>	$T_J = 25 \text{ °C, } I_F = I_S,$ dl/dt = 100 A/µs, V <sub>R</sub> = 25 V		-	462	690	ns
Reverse Recovery Charge	Q <sub>rr</sub>			-	8.3	16	μC
Reverse Recovery Current	I <sub>RRM</sub>			-	30	60	Α

## Note

a. Coss eff. (TR) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDS.

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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

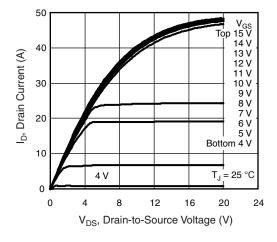


Fig. 1 - Typical Output Characteristics, T<sub>J</sub> = 25 °C

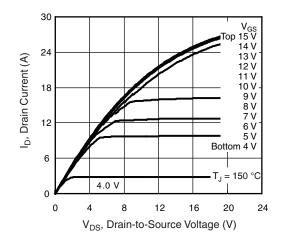


Fig. 2 - Typical Output Characteristics,  $T_J$  = 150 °C

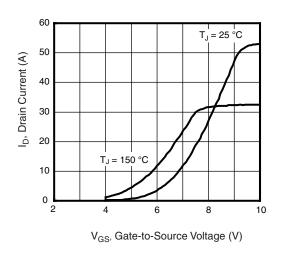


Fig. 3 - Typical Transfer Characteristics

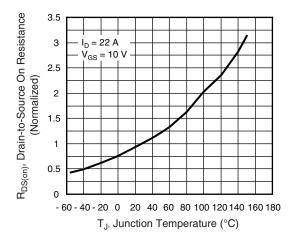


Fig. 4 - Normalized On-Resistance vs. Temperature

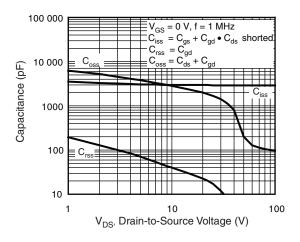


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

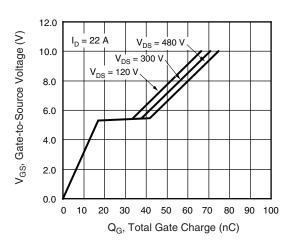


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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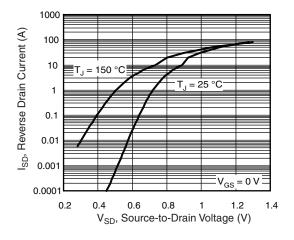


Fig. 7 - Typical Source-Drain Diode Forward Voltage

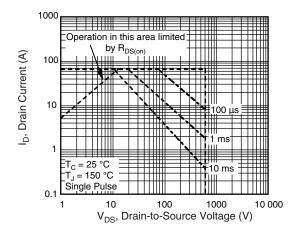


Fig. 8 - Maximum Safe Operating Area

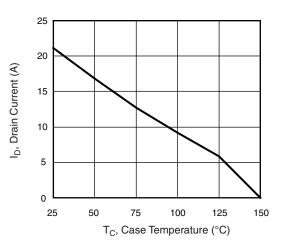


Fig. 9 - Maximum Drain Current vs. Case Temperature

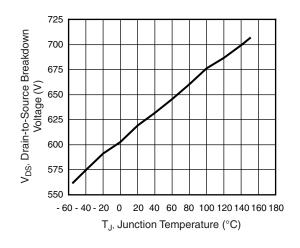
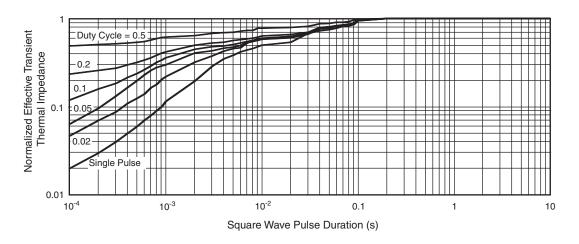


Fig. 10 - Drain-to-Source Breakdown Voltage





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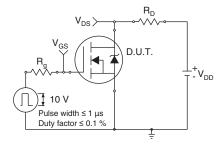


Fig. 12 - Switching Time Test Circuit

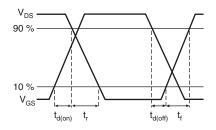


Fig. 13 - Switching Time Waveforms

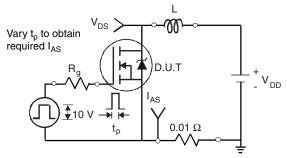


Fig. 14 - Unclamped Inductive Test Circuit

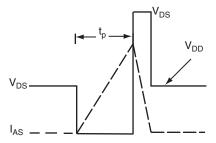


Fig. 15 - Unclamped Inductive Waveforms

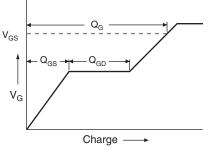


Fig. 16 - Basic Gate Charge Waveform

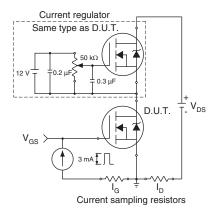


Fig. 17 - Gate Charge Test Circuit

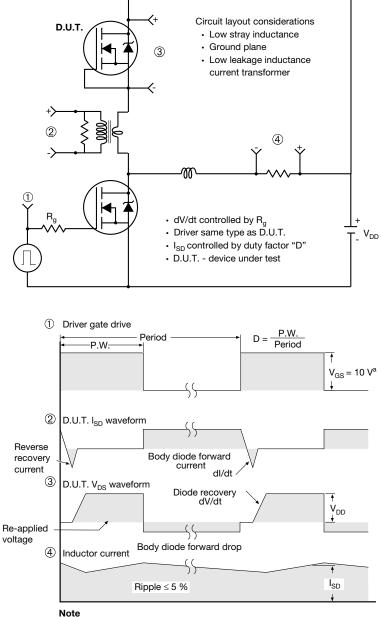
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### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5$  V for logic level devices

Fig. 18 - For N-Channel

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